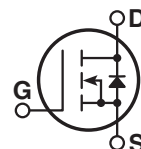
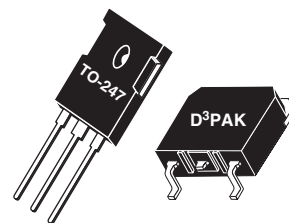




## Super Junction MOSFET

- Ultra Low  $R_{DS(ON)}$
- Low Miller Capacitance
- Ultra Low Gate Charge,  $Q_g$
- Avalanche Energy Rated
- Extreme  $dv/dt$  Rated
- Popular TO-247 or Surface Mount D<sup>3</sup>PAK package.



### MAXIMUM RATINGS

All Ratings per die:  $T_C = 25^\circ\text{C}$  unless otherwise specified.

| Symbol         | Parameter                                                                                              | APT38N60B_SC6 | UNIT             |
|----------------|--------------------------------------------------------------------------------------------------------|---------------|------------------|
| $V_{DSS}$      | Drain-Source Voltage                                                                                   | 600           | Volts            |
| $I_D$          | Continuous Drain Current @ $T_C = 25^\circ\text{C}$                                                    | 38            | Amps             |
|                | Continuous Drain Current @ $T_C = 100^\circ\text{C}$                                                   | 24            |                  |
| $I_{DM}$       | Pulsed Drain Current <sup>1</sup>                                                                      | 112           |                  |
| $V_{GS}$       | Gate-Source Voltage Continuous                                                                         | $\pm 20$      | Volts            |
| $P_D$          | Total Power Dissipation @ $T_C = 25^\circ\text{C}$                                                     | 278           | Watts            |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range                                                       | -55 to 150    | $^\circ\text{C}$ |
| $T_L$          | Lead Temperature: 0.063" from Case for 10 Sec.                                                         | 260           |                  |
| $dv/dt$        | Drain-Source Voltage slope ( $V_{DS} = 480\text{V}$ , $I_D = 38\text{A}$ , $T_J = 125^\circ\text{C}$ ) | 15            | V/ns             |
| $I_{AR}$       | Avalanche Current <sup>2</sup>                                                                         | 6.6           | Amps             |
| $E_{AR}$       | Repetitive Avalanche Energy <sup>2</sup> ( $I_D = 6.6\text{A}$ , $V_{DD} = 50\text{V}$ )               | 1.2           | mJ               |
| $E_{AS}$       | Single Pulse Avalanche Energy ( $I_D = 6.6\text{A}$ , $V_{DD} = 50\text{V}$ )                          | 796           |                  |

### STATIC ELECTRICAL CHARACTERISTICS

| Symbol       | Characteristic / Test Conditions                                                                              | MIN | TYP | MAX       | UNIT          |
|--------------|---------------------------------------------------------------------------------------------------------------|-----|-----|-----------|---------------|
| $BV_{(DSS)}$ | Drain-Source Breakdown Voltage ( $V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$ )                              | 600 |     |           | Volts         |
| $R_{DS(on)}$ | Drain-Source On-State Resistance <sup>3</sup> ( $V_{GS} = 10\text{V}$ , $I_D = 18\text{A}$ )                  |     |     | 0.099     | Ohms          |
| $I_{DSS}$    | Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ )                             |     |     | 25        | $\mu\text{A}$ |
|              | Zero Gate Voltage Drain Current ( $V_{DS} = 600\text{V}$ , $V_{GS} = 0\text{V}$ , $T_C = 150^\circ\text{C}$ ) |     |     | 100       |               |
| $I_{GSS}$    | Gate-Source Leakage Current ( $V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$ )                              |     |     | $\pm 100$ | nA            |
| $V_{GS(th)}$ | Gate Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 1.2\text{mA}$ )                                           | 2.5 | 3   | 3.5       | Volts         |



CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

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Microsemi Website - <http://www.microsemi.com>

# DYNAMIC CHARACTERISTICS

APT38N60B\_SC6

| Symbol       | Characteristic                        | Test Conditions                                                                                                  | MIN | TYP  | MAX | UNIT    |
|--------------|---------------------------------------|------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------|
| $C_{iss}$    | Input Capacitance                     | $V_{GS} = 0V$<br>$V_{DS} = 25V$<br>$f = 1\text{ MHz}$                                                            |     | 2826 |     | pF      |
| $C_{oss}$    | Output Capacitance                    |                                                                                                                  |     | 2428 |     |         |
| $C_{rss}$    | Reverse Transfer Capacitance          |                                                                                                                  |     | 261  |     |         |
| $Q_g$        | Total Gate Charge <sup>4</sup>        | $V_{GS} = 10V$<br>$V_{DD} = 300V$<br>$I_D = 38A @ 25^\circ C$                                                    |     | 112  |     | nC      |
| $Q_{gs}$     | Gate-Source Charge                    |                                                                                                                  |     | 18   |     |         |
| $Q_{gd}$     | Gate-Drain ("Miller") Charge          |                                                                                                                  |     | 58   |     |         |
| $t_{d(on)}$  | Turn-on Delay Time                    | <b>INDUCTIVE SWITCHING</b><br>$V_{GS} = 15V$<br>$V_{DD} = 400V$<br>$I_D = 38A @ 25^\circ C$<br>$R_G = 4.3\Omega$ |     | 14   |     | ns      |
| $t_r$        | Rise Time                             |                                                                                                                  |     | 29   |     |         |
| $t_{d(off)}$ | Turn-off Delay Time                   |                                                                                                                  |     | 118  |     |         |
| $t_f$        | Fall Time                             |                                                                                                                  |     | 69   |     |         |
| $E_{on}$     | Turn-on Switching Energy <sup>5</sup> | <b>INDUCTIVE SWITCHING @ 25°C</b><br>$V_{DD} = 400V, V_{GS} = 15V$<br>$I_D = 38A, R_G = 4.3\Omega$               |     | 710  |     | $\mu J$ |
| $E_{off}$    | Turn-off Switching Energy             |                                                                                                                  |     | 550  |     |         |
| $E_{on}$     | Turn-on Switching Energy <sup>5</sup> | <b>INDUCTIVE SWITCHING @ 125°C</b><br>$V_{DD} = 400V, V_{GS} = 15V$<br>$I_D = 38A, R_G = 4.3\Omega$              |     | 1100 |     |         |
| $E_{off}$    | Turn-off Switching Energy             |                                                                                                                  |     | 625  |     |         |

# SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol    | Characteristic / Test Conditions                                 | MIN                | TYP | MAX | UNIT    |
|-----------|------------------------------------------------------------------|--------------------|-----|-----|---------|
| $I_S$     | Continuous Source Current (Body Diode)                           |                    |     | 33  | Amps    |
| $I_{SM}$  | Pulsed Source Current <sup>1</sup> (Body Diode)                  |                    |     | 112 |         |
| $V_{SD}$  | Diode Forward Voltage <sup>3</sup> ( $V_{GS} = 0V, I_S = -38A$ ) |                    |     | 1.3 | Volts   |
| $dv/dt$   | Peak Diode Recovery $dv/dt$ <sup>6</sup>                         |                    |     | 8   | V/ns    |
| $t_{rr}$  | Reverse Recovery Time<br>( $I_S = -38A, di/dt = 100A/\mu s$ )    | $T_J = 25^\circ C$ | 667 |     | ns      |
| $Q_{rr}$  | Reverse Recovery Charge<br>( $I_S = -38A, di/dt = 100A/\mu s$ )  | $T_J = 25^\circ C$ | 18  |     | $\mu C$ |
| $I_{RRM}$ | Peak Recovery Current<br>( $I_S = -38A, di/dt = 100A/\mu s$ )    | $T_J = 25^\circ C$ | 49  |     | Amps    |

# THERMAL CHARACTERISTICS

| Symbol          | Characteristic      | MIN | TYP | MAX  | UNIT         |
|-----------------|---------------------|-----|-----|------|--------------|
| $R_{\theta JC}$ | Junction to Case    |     |     | 0.45 | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction to Ambient |     |     | 40   |              |

1 Repetitive Rating: Pulse width limited by maximum junction temperature

2 Repetitive avalanche causes additional power losses that can be calculated as

$$P_{AV} = E_{AR} \cdot f, \text{ Pulse width } tp \text{ limited by } T_J \text{ max.}$$

3 Pulse Test: Pulse width < 380  $\mu s$ , Duty Cycle < 2%

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

4 See MIL-STD-750 Method 3471

5  $E_{on}$  includes diode reverse recovery.

6 Maximum 125°C diode commutation speed =  $di/dt$  600A/ $\mu s$

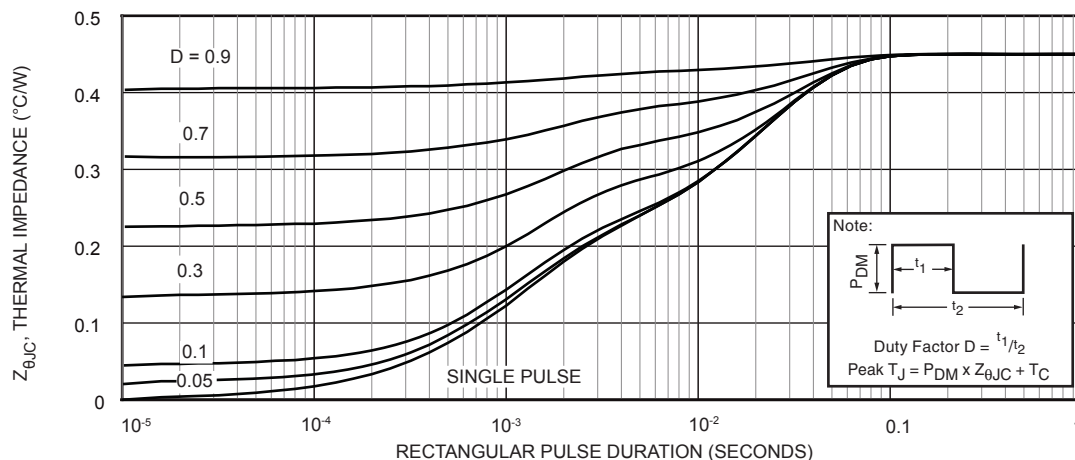


Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

# Typical Performance Curves

APT38N60B\_SC6

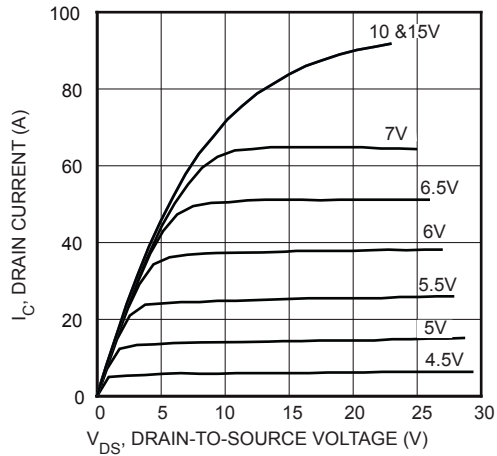


FIGURE 2, Low Voltage Output Characteristics

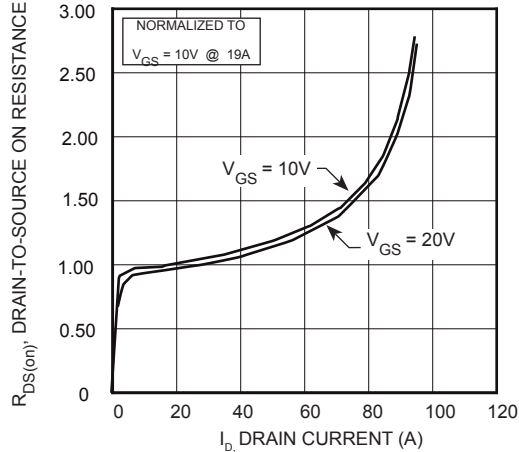


FIGURE 4,  $R_{DS(on)}$  vs Drain Current

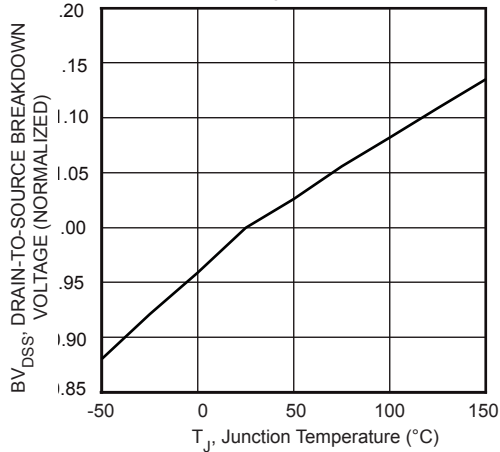


FIGURE 6, Breakdown Voltage vs Temperature

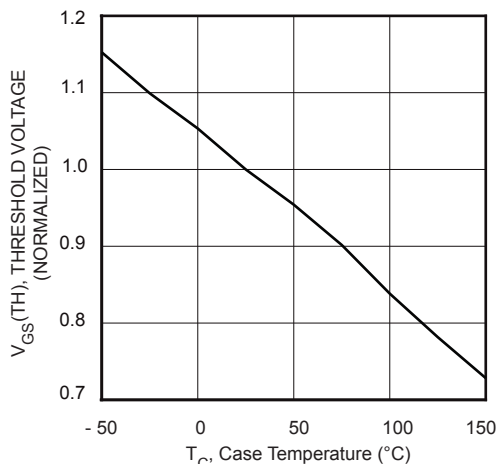


FIGURE 8, Threshold Voltage vs Temperature

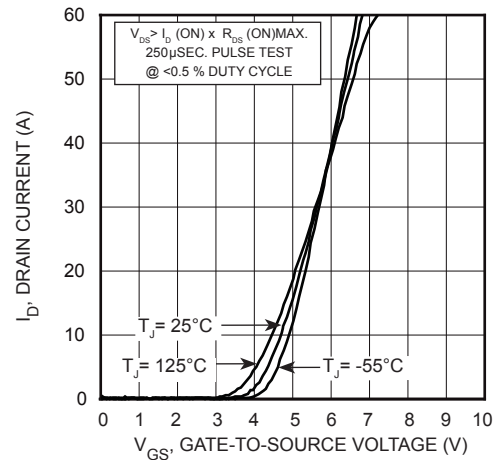


FIGURE 3, Transfer Characteristics

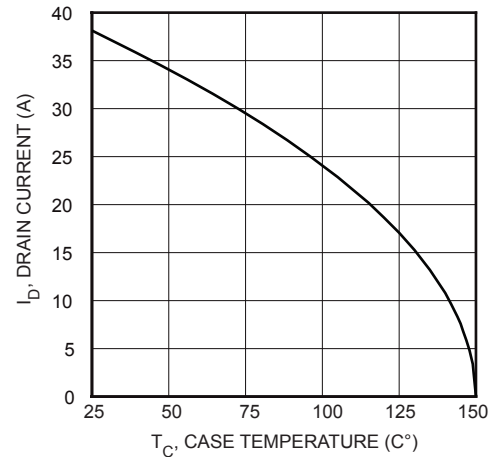


FIGURE 5, Maximum Drain Current vs Case Temperature

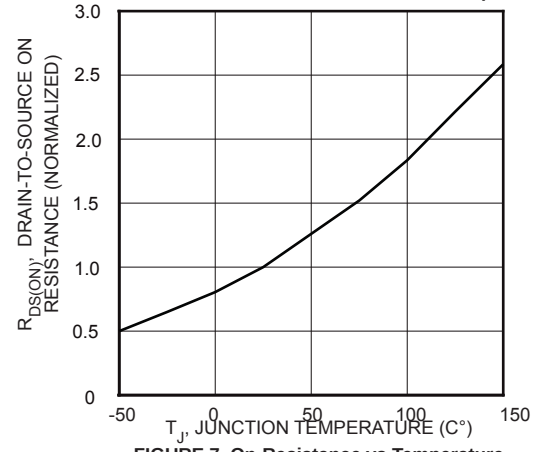


FIGURE 7, On-Resistance vs Temperature

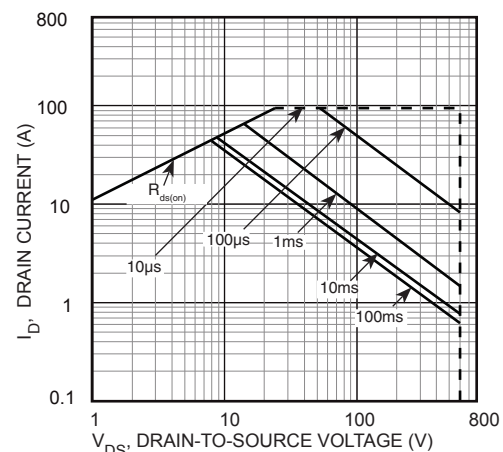


FIGURE 9, Maximum Safe Operating Area

## Typical Performance Curves

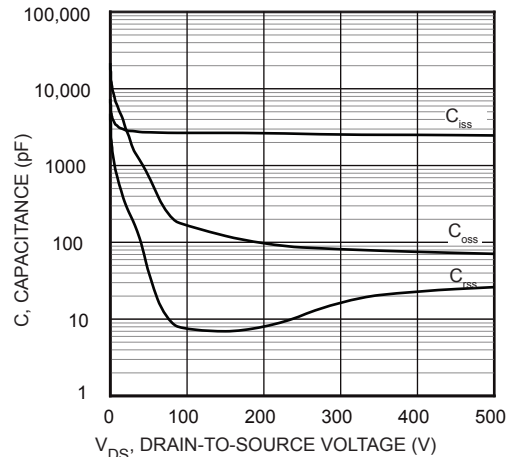


FIGURE 10, Capacitance vs Drain-To-Source Voltage

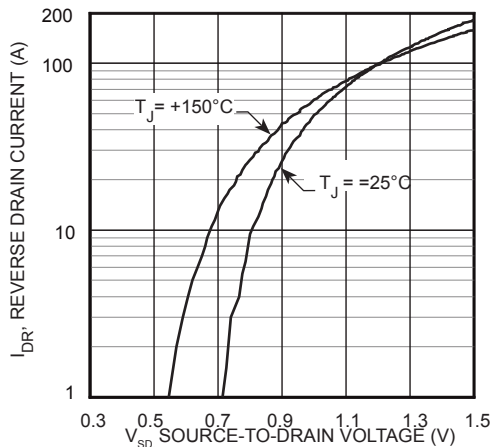


FIGURE 12, Source-Drain Diode Forward Voltage

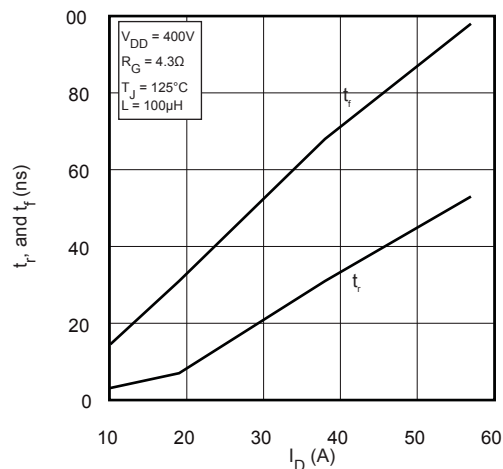


FIGURE 14, Rise and Fall Times vs Current

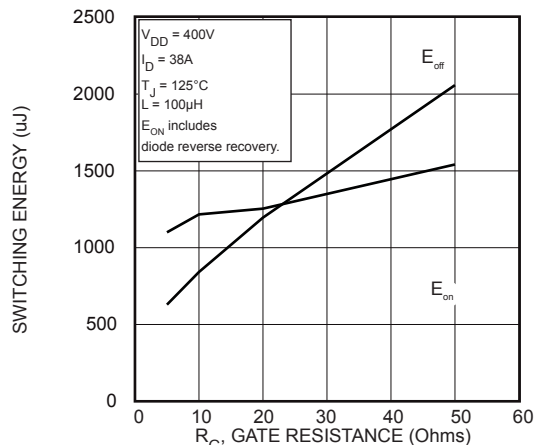


FIGURE 16, Switching Energy vs Gate Resistance

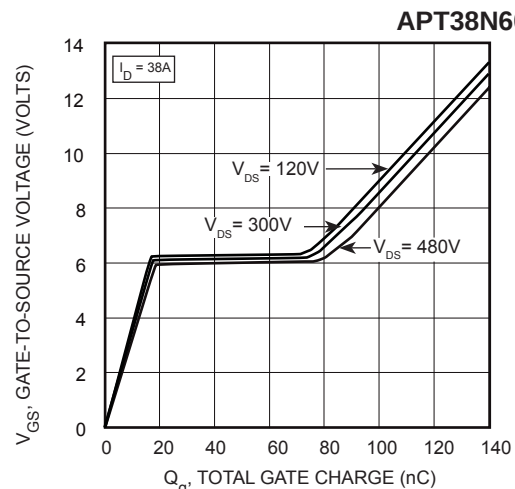


FIGURE 11, Gate Charges vs Gate-To-Source Voltage

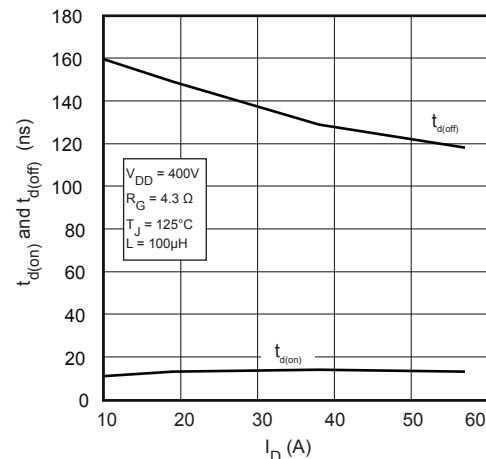


FIGURE 13, Delay Times vs Current

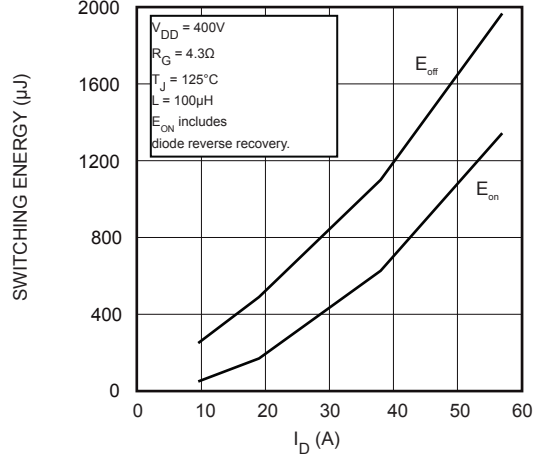


FIGURE 15, Switching Energy vs Current

## Typical Performance Curves

APT38N60B\_SC6

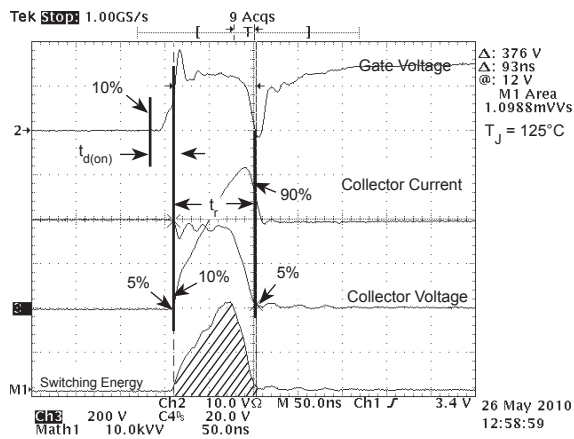


Figure 17, Turn-on Switching Waveforms and Definitions

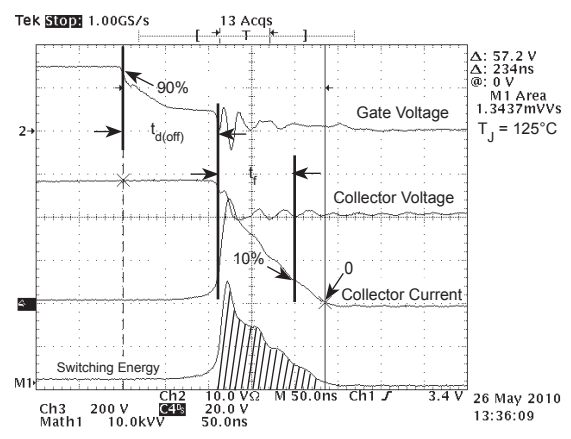


Figure 18, Turn-off Switching Waveforms and Definitions

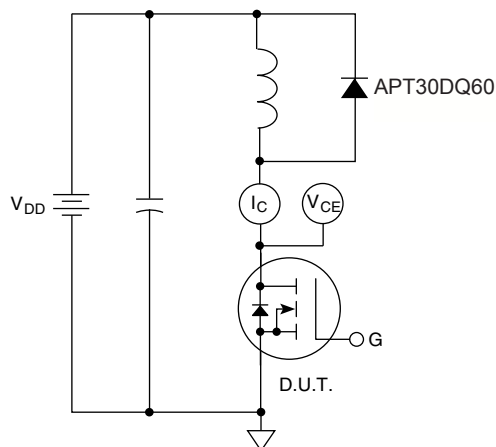
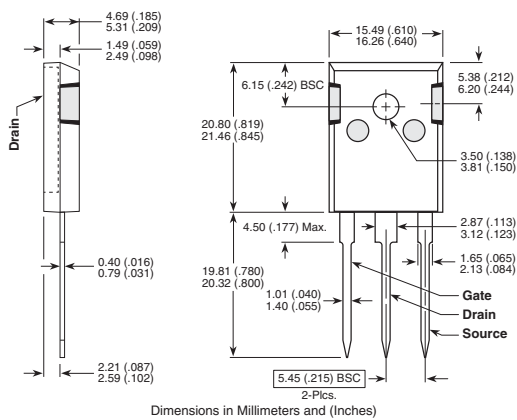


Figure 19, Inductive Switching Test Circuit

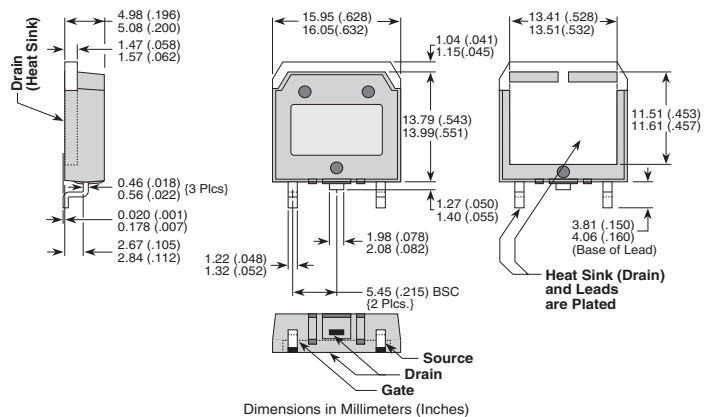
## TO-247 (B) Package Outline



Dimensions in Millimeters and (Inches)

## D<sup>3</sup>PAK Package Outline

Ⓔ3 100% Sn Plated



Dimensions in Millimeters (Inches)